









## 1st BMEMat-Advanced Materials Joint Symposium-**Invitation**

Subject: Invitation to the 1st BMEMat-Advanced Materials Joint Symposium

Dear Scholars,

We are pleased to invite you to participate in the 1st BMEMat-Advanced Materials Joint Symposium, which will be held from August 13th to 16th, 2024, at The Chinese University of Hong Kong. This symposium, co-organized by Shandong University and Wiley, and hosted by The Chinese University of Hong Kong and the BMEMat editorial office, will bring together leading scholars in the field of biomaterials from around the world.

The symposium aims to provide invaluable opportunities to engage with cutting-edge research, connect with editors from top journals such as Nature BME, foster communication with international experts in biomedical engineering materials, and strengthen ties with international colleagues. The event will feature plenary talks by leading scientists and top-tier journal editors, as well as an award ceremony for the BMEMat Lifetime Achievement Award Winner (Prof. Nicholas Peppas). This high-end academic event will offer a platform for gaining deep insights into the latest advances in biomedical research, expanding your perspectives, networking with peers, and promoting collaboration and innovation in the field.

We sincerely invite you to honor us with your presence at this significant academic gathering in Hong Kong. Your participation will undoubtedly contribute to the success of the symposium, and we look forward to welcoming you and benefiting from your expertise.

We hope to see you in Hong Kong!

Sincerely,

Symposium Chairs:

Chuanbin Mao, Global STEM Professor, The Chinese University of Hong Kong, China

Muambin Mas

Hong Liu, Editor-in-Chief, BMEMat, Professor, Shandong University, China











	Editor panel discussion of Nature		
Type	Student	Regular	BME/AM/BM/Matter
Early bird price until July 1, 2024	250USD	450USD	80USD
	2000HKD	3600HKD	640HKD
	1875RMB	3375RMB	600RMB
On-site payment	350USD	550USD	80USD
	2800HKD	4400HKD	640HKD
	2625RMB	4125RMB	600RMB
1.中国香港 Hongkong, China	Bank Transfer		3333312
	Account Name: Green Leaf Energy Technology Company Limited		
	Bank Name: OCBC Wing Hang Bank Limited		
	Bank Address:161 Queen's Road Central Hong Kong		
	Swift Code: WIHBHKHH		
	Account Number: 035-802-806084-831		
	Bank Code: 035		
	Branch Code: 802		
	Operation Address: 1220 Tower 1, 8 Metropolis Road, Hung Hom Bay, Yau Tsim Mong District, Kowloon,		
	Hong Kong		
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	<b>19.00</b> (40.00)		
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2.中国大陆 Chinese mainland	1. 银行转账 Bank Transfer(请先完成会议注册,付款时备注参会人姓名、单位 Please complete the		
	conference registration first and note the participant's name and unit when making payment.)		
	户 名 Account Name: 广东海巍科技有限公司		
	开户银行 Bank Name: 中国工商银行股份有限公司中山翠亨新区支行		
	账 号 Account Number: 201100090900086777		
	2. 微信/支付宝 WeChat/Alipay(请先完成会议注册,付款时备注参会人姓名、单位 Please complete t		
	conference registration first and note the participant's name and unit when making payment.)		
3.Pay with credit card	Login to the official website of the conference to register and pay the fee		
	Official website of the Co	onference: https://seps	sg.org/HongKong24/
	2. Quick Enrolment Website	e: https://sepsg.org/Ho	ongKong24/2024-2/
	3. Charging Standard (USD) and other overseas payment links :		
	Regular \$550: https://buy.s	tripe.com/9AQ5od47	F5JSgo0bIT
	Student \$350: https://buy.stripe.com/5kA6shfQn4FOdbO6oA		
	Discussion group \$80: <a href="https://buy.stripe.com/cN2bMB8nVgow6Nq8wD">https://buy.stripe.com/cN2bMB8nVgow6Nq8wD</a>		
	Student+Discussion group \$430: <a href="https://buy.stripe.com/bIYbMB5bJ4FOfjWfZb">https://buy.stripe.com/bIYbMB5bJ4FOfjWfZb</a>		
	Regular+Discussion group \$630: <a href="https://buy.stripe.com/00gcQF9rZ5JS2xa00e">https://buy.stripe.com/00gcQF9rZ5JS2xa00e</a>		
	1. If you choose to attend the Editor panel discussion of Nature BME/AM/BM/Matter, please choose		
	the payment plus the Editor panel discussion of Nature BME/AM/BM/Matter attendance fee.		
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making payment.)